As an inventor named below or on any attached continuation page, I hereby declare that:

My residence, post office address and citizenship are as stated next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled SLURRY FOR USE WITH FIXED-ABRASIVE POLISHING PADS IN POLISHING SEMICONDUCTOR DEVICE CONDUCTIVE STRUCTURES THAT INCLUDE COPPER AND TUNGSTEN AND POLISHING METHODS, the specification of which (check one):

| is attached hereto. | | | | | |
|---|--|---|---|-----------------------------------|------------|
| | s United States application serial no | and was amende | d on | | |
| □ was filed on as | s PCT international application no. | and was amended | under PCT Article 19 on | | |
| I hereby state that I have reviewe | ed and understand the contents of the above | e-identified specification | , including the claims, as amend | ed by any amen | dment |
| referred to above. | | | | .,, | |
| | | 11.6 | | | |
| | se to the U.S. Patent and Trademark Office | | | itability of the s | ubject |
| matter claimed in this application, as | s "materiality" is defined in Title 37, Code | OI rederat Regulations | g 1.50. | | |
| I hereby claim foreign priority b | enefits under Title 35, United States Code, | , § 119(a)-(d) or § 365(t | o) of any foreign application(s) for | or patent or inve | entor's |
| | nternational application(s) designating at lea | | | - | |
| | also identified below and on any attached | | | | |
| • • | ignating at least one country other than the | United States of Americ | ca having a filing date before tha | t of the applicat | ion(s) on |
| which priority is claimed. | | | | | |
| Prior foreign/PCT application(s): | | | | | |
| | | | | Priority Claim | ned |
| | | | (1 to 4) (2) | | |
| (number) | (coun | try) | (day/month/year filed) | Yes | No |
| | | | | | |
| (number) | (coun | try) | (day/month/year filed) | Yes | No |
| | Title 35, United States Code, § 120 of any | | | • | |
| application is not disclosed in any suclety to disclose to the U.S. Patent ar | erica listed below and on any attached cont ch prior application in the manner provide and Trademark Office all information know | d by the first paragraph n to me to be material to | of Title 35, United States Code, patentability as defined in Title | § 112, I acknow 37, Code of Fe | wledge the |
| Regulations § 1.56 which became ava | ailable between the filing date of such prio | r application and the nat | tional or PCT international filing | date of this app | olication: |
| | | | | | |
| (application serial no.) | (filing date) | | (status - pending, patented or | abandoned) | |
| (application serial no.) | (filing date) | | (status - pending, patented or | abandoned) | |
| (application serial no.) | (mmg asso) | | (battas penama, paterios or | availdorica) | |
| | | | | | |
| I hereby claim the benefit under I | Title 35, United States Code, § 119(e) of a | ny United States provisi | onal application(s) listed below: | | |
| | | | | | |
| (provisional application no | o.) (filing date) | | | | |
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| | the transfer of the state of th | | Mark of the first of the second of the | | |
| I hereby appoint the following Reperewith: | gistered Practitioners to prosecute this app | lication and to transact a | Ill business in the Patent and Tra | demark Office of | connected |
| David V. Trask, Reg. No. 22,012 | | | aurence B. Bond, Reg. No. 30, | | |
| Joseph A. Walkowski, Reg. No. 2 Edgar R. Cataxinos, Reg. No. 39, | oseph A. Walkowski, Reg. No. 28,765 Adgar R. Cataxinos, Reg. No. 39,931 Kent S. Burningham, Reg. No. 30,453 | | Allen C. Turner, Reg. No. 33,041 Stephen R. Christian, Reg. No. 32,687 | | |
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| | | | | | |

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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DECLARATION FOR PATENT APPLICATIO (continuation page)

Invention title: SLURRY FOR USE WITH FIXED-ABRASIVE POLISHING PADS IN POLISHING SEMICONDUCTOR DEVICE CONDUCTIVE STRUCTURES THAT INCLUDE COPPER AND TUNGSTEN AND POLISHING METHODS

Inventor name(s) appearing on first declaration page: Dinesh Chopra

Additional original, first and joint inventor(s):

Full name of second joint inventor: Nishant Sinha Inventor's signature Residence: Boise, Idaho

Date 8/29/00

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